

3.0mmx1.0 mm RIGHT ANGLE SMD CHIP LED LAMP



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: KPA-3010VGC-A

GREEN

Features

- •3.0mmx1.0mm RIGHT ANGLE SMT LED, 2.0mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACK LIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- ●PACKAGE: 2000PCS/REEL.
- •MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- ●RoHS COMPLIANT.

Description

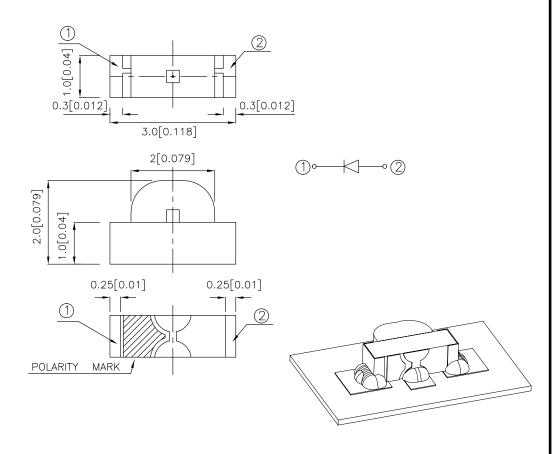
The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. Specifications are subject to change without notice.
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.

(Pb)



SPEC NO: DSAG9435 REV NO: V.4 DATE: JUN/22/2007 PAGE: 1 OF 4
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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
		,,,	Min.	Тур.	2 θ 1/2
KPA-3010VGC-A	GREEN (InGaN)	WATER CLEAR	70	180	120°

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2.Luminous Intensity / Luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	520		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	35		nm	IF=20mA
С	Capacitance	Green	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	4.0	V	IF=20mA
lr	Reverse Current	Green		10	uA	VR = 5V

Notes:

- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at Ta=25°C

Parameter	Green	Units	
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

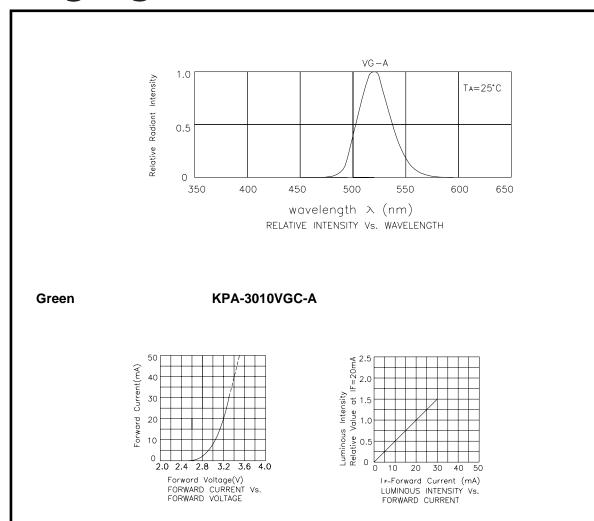
Note:

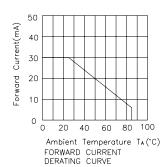
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

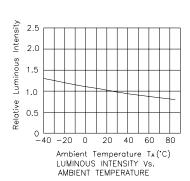
SPEC NO: DSAG9435 **REV NO: V.4** DATE: JUN/22/2007 PAGE: 2 OF 4 DRAWN: S.J.LIU

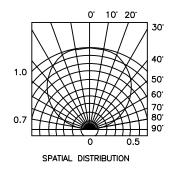
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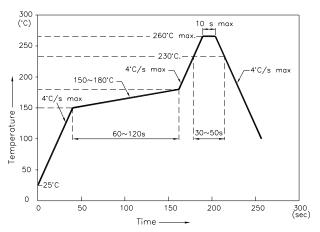
SPEC NO: DSAG9435 **REV NO: V.4** DATE: JUN/22/2007 PAGE: 3 OF 4 **CHECKED: Allen Liu** DRAWN: S.J.LIU

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KPA-3010VGC-A

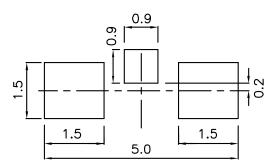
Reflow Soldering Profile For Lead-free SMT Process.



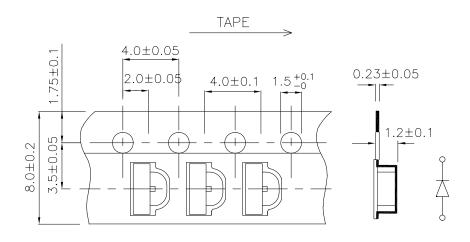
NOTES:

- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Specifications (Units: mm)



SPEC NO: DSAG9435 APPROVED: WYNEC REV NO: V.4 CHECKED: Allen Liu DATE: JUN/22/2007 DRAWN: S.J.LIU PAGE: 4 OF 4